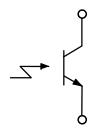




The QSB363 is a silicon phototransistor encapsulated in a black infrared transparent T-3/4 package.



• T

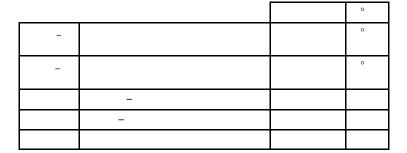






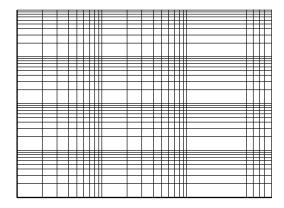






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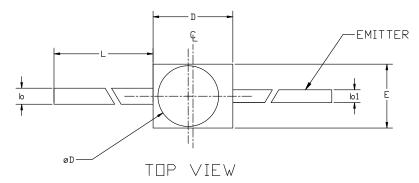


CASE 100CB ISSUE A

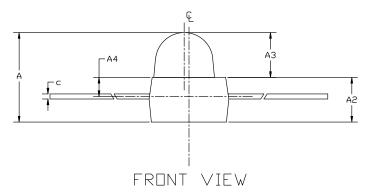
DATE 14 SEP 2023

NOTES:

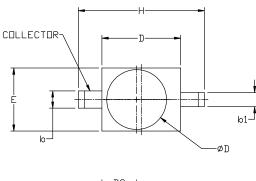
- 1. CONTROLLING DIMENSIONS: MILLIMETERS
- 2. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
- 3. 2MM DETECTOR

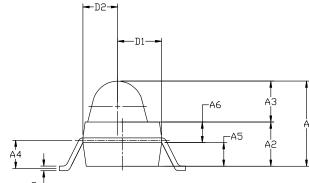


	MILLIMETERS					
DIM	MIN.	N□M.	MAX.			
Α						
	1.30	1.40	1.50			
А3	1.30	1.40	1.50			
Α4	0,60 REF					
b	_	0.55	0.65			
b1	0.35	0.45	0.55			
U	0.10	0.15	0.25			
	2.30		2.70			
E	1.80	2.00	2.20			
	7.00					
øD	1.70	1.90	2.10			









RECOMMENDED MOUNTING FOOTPRINT*

*FOR ADDITIONAL INFORMATION ON OUR P6-FREE STP

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- 2. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
- 3. 2MM YOKE DETECTOR.

	0.650	0.750	0.850	
A5	0.550	0.650	0.750	
b	0.450	0.550	0.650	
b1	0.350	0.450	0.550	
c	0.100	0.150	0.200	
D	2.300	2.500	2.700	
D1	1.200	1.400	1.600	
D2	0.900	1.100	1.300	
Ε	¹.∖ING	DIMENS	IONS: MILLIMET	ΓΕΓ

BOTTOM VIEW

RECOMMENDED MOUNTING FOOTPRINT*

*FOR ADDITIONAL INFORMATION ON OUR P6-FREE

STRATEGY AND SOLDERING DETAILS



T-3/4 2.50x2.00 CASE 100EK ISSUE O

DATE 14 SEP 2023

RECOMMENDED MOUNTING FOOTPRINT* *FOR A

